

Product data sheet

1. General description

Ultrafast power diode in a SMC package.

2. Features and benefits

- · Fast switching
- SMC package
- High voltage capability
- Low forward voltage drop
- Low leakage current
- Low thermal resistance
- Soft recovery characteristic

3. Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- High frequency switched-mode power supplies

4. Quick reference data

Symbol	Parameter	Conditions	Values				Unit
	maximum rating						
V_{RRM}	repetitive peak reverse voltage			6	00		V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{lead} ≤ 96 °C; Fig. 1; Fig. 2; Fig. 3		5			A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 μs; T _{lead} ≤ 96 °C; square-wave pulse	10				A
I _{FSM}	non-repetitive peak forward current	$t_{\rm p}$ = 10 ms; $T_{\rm j(init)}$ = 25 °C; sine-wave pulse; <u>Fig. 4</u>	130			A	
		t_{p} = 8.3 ms; $T_{j(\text{init})}$ = 25 °C; sine-wave pulse	143		А		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 5 A; T _j = 25 °C		-	1.10	1.35	V
		I _F = 5 A; T _j = 150 °C		-	0.9	1.15	V
Dynamic	characteristics						
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt= 50 A/us; T _i = 25 °C; <u>Fig. 7</u>		-	45	-	ns

5. Pinning information

Table	2.	Pinning	information
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Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	A	anode		K — A 001aaa020

6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
MUR560	SMC	MUR560J	Reel	3000	SMCS	16-Aug-2017		

7. Marking

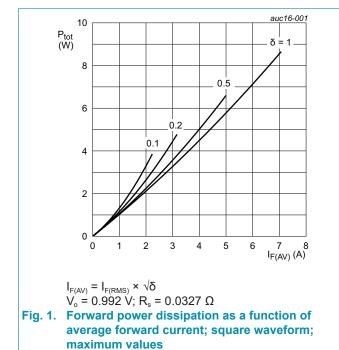
Table 4. Marking codes						
	Type number	Marking codes				
	MUR560	560JS				

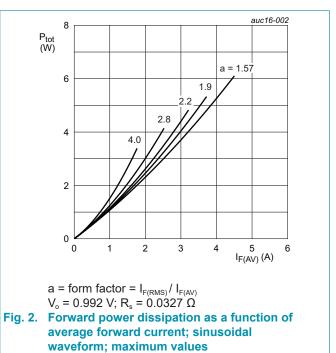
8. Limiting values

Table 5. Limiting values

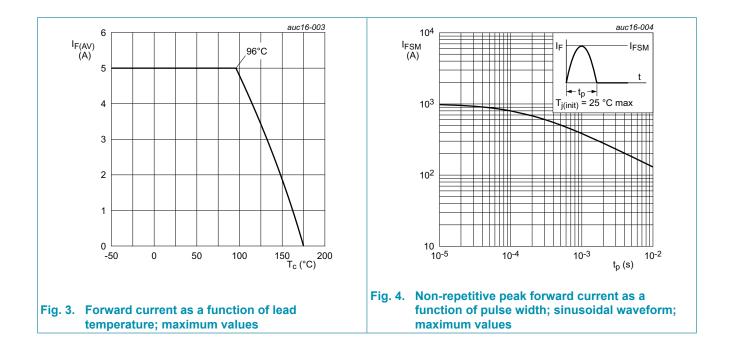
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V_{RWM}	crest working reverse voltage		600	V
V _R	reverse voltage	DC	600	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{lead} ≤ 96 °C; Fig. 1; Fig. 2; Fig. 3	5	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{lead} ≤ 96 °C; square-wave pulse	10	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; Fig. 4	130	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	143	А
T _{stg}	storage temperature		-65 to 175	°C
Tj	junction temperature		175	°C



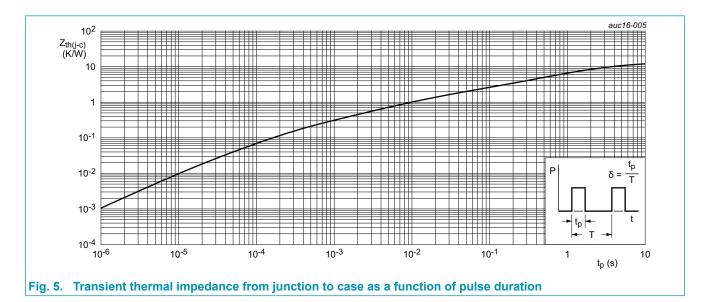


MUR560 Ultrafast power diode



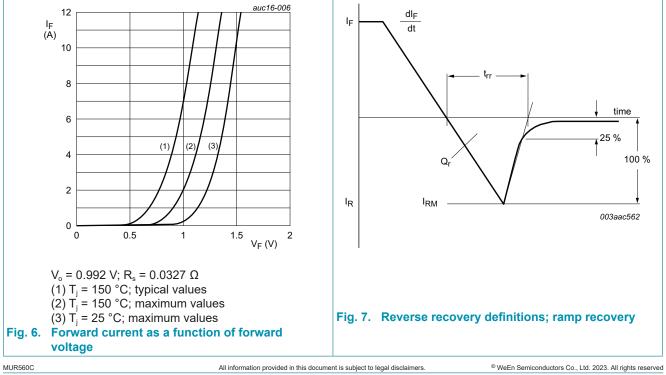
9. Thermal characteristics

Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	mounted on a minimum footprint printed-circuit board (FR4); <u>Fig. 5</u>	-	-	12	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	mounted on a minimum footprint printed-circuit board (FR4)	-	75	-	K/W

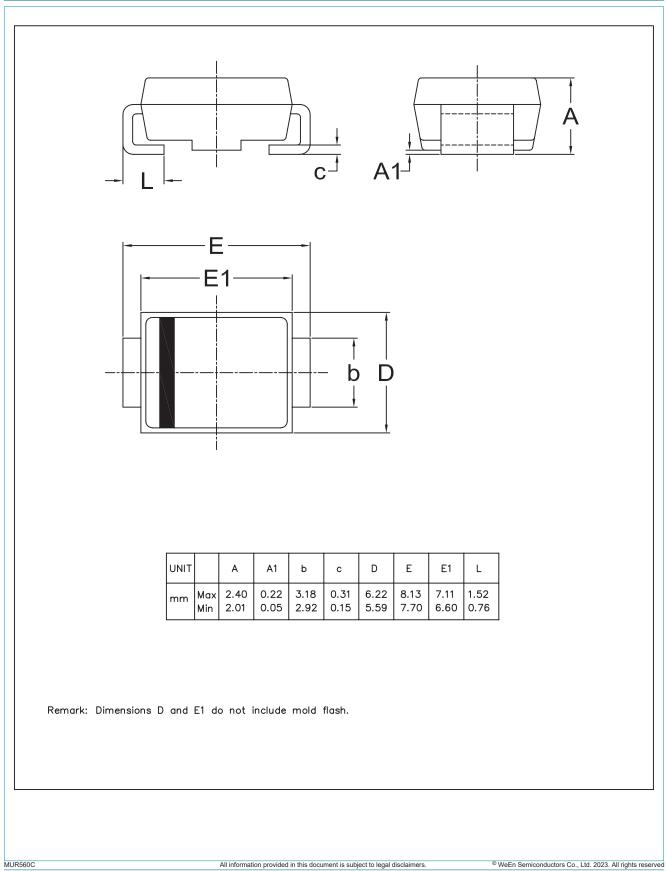


10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
V _F	forward voltage	ward voltage $I_F = 5 \text{ A}; T_j = 25 \text{ °C}; Fig. 6$		1.10	1.35	V
		I _F = 5 A; T _j = 150 °C; <u>Fig. 6</u>	-	0.9	1.15	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	-	3	μA
		V _R = 600 V; T _j = 150 °C	-	-	250	μA
Dynamic	characteristics			,		
Q _r	reverse charge	$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 100 \text{ A/us};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	216	-	nC
		$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 100 \text{ A/us};$ $T_j = 125 \text{ °C}; Fig. 7$	-	420	-	nC
t _{rr}	reverse recovery time	I _F = 1 A; V _R = 30 V; dI _F /dt= 50 A/us; T _j = 25 °C; <u>Fig. 7</u>	-	45	-	ns
		$I_{F} = 0.5 \text{ A}; I_{R} = 1 \text{ A}; I_{R(meas)} = 0.25 \text{ A};$ $T_{j} = 25 \text{ °C}; \text{ Step recovery}$	-	-	65	ns
		$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 100 \text{ A/us};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	64	-	ns
		I _F = 5 A; V _R = 400 V; dI _F /dt = 100 A/us; T _j = 125 °C; <u>Fig. 7</u>	-	88	-	ns
I _{RM}	peak reverse recovery current	$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 100 \text{ A/us};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	6.7	-	A
		$I_F = 5 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 100 \text{ A/us};$ $T_j = 125 \text{ °C}; Fig. 7$	-	9.5	-	A
E _{as}	non-repetitive avalanche energy	I _R = 1.2 A; T _{j(init)} = 25 °C; L = 15 mH	10.8	-	-	mJ



11. Package outline



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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